

SERIES: SF500G | DESCRIPTION: THERMAL PAD

FEATURES

- 3.5 W/m*K thermal conductivity
- naturally tacky
- silicone based
- electrical isolation
- sizes to match CUI peltier footprints



SPECIFICATIONS

parameter	test method/conditions/description	min	typ	max	units
material	silicone elastomer				
color	blue				
thickness	ASTM D751		0.5		mm
specific gravity	ASTM D297		3.0		g/cc
hardness	ASTM D2240	25		80	shore 00
tensile strength	ASTM D412		25		psi
continuous use temperature		-58		200	°C
dielectric breakdown voltage	ASTM D149	2500			V
dielectric constant [1 MHz]	ASTM D150		6.0		
volume resistivity	ASTM D257		10 ¹³		Ω*cm
thermal conductivity	ASTM D5470		3.5		W/m*K
RoHS	yes				

PART NUMBER KEY

SF500G - XXXX 05

Base Number

Footprint Size (mm):

10x10 = 1010
 15x15 = 1515
 15x30 = 1530
 20x20 = 2020
 20x40 = 2040
 26.25x50 = 2650
 30x12 = 3012
 30x30 = 3030
 31.25x30 = 3130
 40x40 = 4040
 41.25x45 = 4145
 50x50 = 5050
 70x70 = 7070

REVISION HISTORY

rev.	description	date
1.0	initial release	11/02/2018
1.01	brand update	03/24/2020
1.02	logo, datasheet style update	08/05/2022

The revision history provided is for informational purposes only and is believed to be accurate.